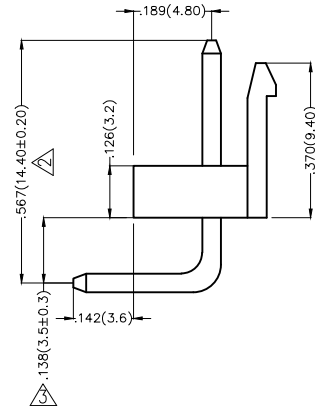
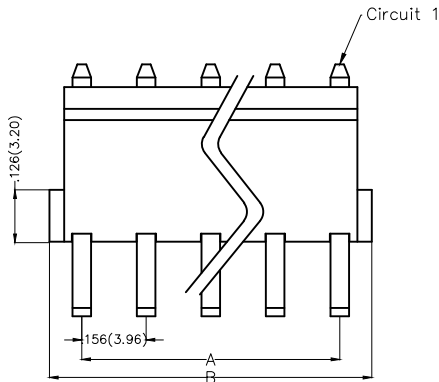
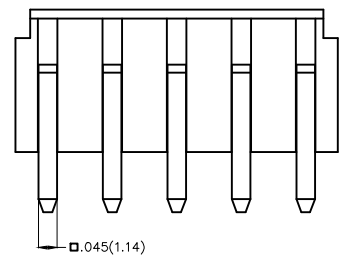


REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1		Dimension: $\phi.065(\phi1.65)$ Change to $\phi.071(\phi1.80)$	20150919	CHERRY	FAN
2		Dimension: $.587(14.90)$ Change to $.567(14.40)$	20171127	VERNON	
3		Add dimension	26/APR/19	KATE	FRANK



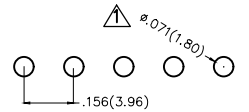
Electrical
 Current Rating: 7A AC(rms)/DC
 Voltage Rating: 250V AC(rms)/DC
 Contact Resistance: 10 m Ω Max
 Insulation Resistance: 1000 M Ω MIN
 Withstanding Voltage: 1500V AC r.m.s
 Temperature Range—Operating: -25°C~+85°C
Material and Plating
 Housing: PA6T(UL 94V-0)/PA66(UL 94V-0)
 Contact Pin: Brass
 Plating: Tin Plated



Ordering Information

FWF 396 02 — S XX B 2 X XX B
 1 2 3 4 5 6 7 8 9 10

1 Category FWF—Wafer	2 Series Number 396—Pitch 3.96mm	3 Distinction No. 02	4 Row Option S—Single Row	5 Circuits xx	6 Entry Angle B—90° Angle
7 Plating 2—Tin Plated	8 Material—Resin 2—PA66 4—PA6T	9 Color—Resin W1—White W5—White	10 Packaging B—PE Bag		



Recommended P.C.Board Layout

	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 19/SEP/15	PART NO. FWF39602—SXXB2XXXB	ITEM NO. FWF39602	
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X'.±5'	CHECKED BY CHERRY	DATE 19/SEP/15	TITLE Wire to Board (Wafer) Pitch 3.96mm 90° Angle (DIP)		
SCALE 5:1	SIZE A4	X.XX±.006(0.15) .XX'±1'	DRAWN BY JACOB	DATE 19/SEP/15	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

Material and Plating : Housing PA66 UL94V-0 , Tin Plated.			
Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF39602-S02B22W1B	.156(3.96)	.311(7.92)
3	FWF39602-S03B22W1B	.311(7.92)	.468(11.88)
4	FWF39602-S04B22W1B	.468(11.88)	.624(15.84)
5	FWF39602-S05B22W1B	.624(15.84)	.780(19.80)
6	FWF39602-S06B22W1B	.780(19.80)	.935(23.76)
7	FWF39602-S07B22W1B	.935(23.76)	1.091(27.72)
8	FWF39602-S08B22W1B	1.091(27.72)	1.247(31.68)
9	FWF39602-S09B22W1B	1.247(31.68)	1.403(35.64)
10	FWF39602-S10B22W1B	1.403(35.64)	1.559(39.60)
11	FWF39602-S11B22W1B	1.559(39.60)	1.715(43.56)
12	FWF39602-S12B22W1B	1.715(43.56)	1.871(47.52)

Material and Plating : Housing PA6T UL94V-0 , Tin Plated.			
Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF39602-S02B24W5B	.156(3.96)	.311(7.92)
3	FWF39602-S03B24W5B	.311(7.92)	.468(11.88)
4	FWF39602-S04B24W5B	.468(11.88)	.624(15.84)
5	FWF39602-S05B24W5B	.624(15.84)	.780(19.80)
6	FWF39602-S06B24W5B	.780(19.80)	.935(23.76)
7	FWF39602-S07B24W5B	.935(23.76)	1.091(27.72)
8	FWF39602-S08B24W5B	1.091(27.72)	1.247(31.68)
9	FWF39602-S09B24W5B	1.247(31.68)	1.403(35.64)
10	FWF39602-S10B24W5B	1.403(35.64)	1.559(39.60)
11	FWF39602-S11B24W5B	1.559(39.60)	1.715(43.56)
12	FWF39602-S12B24W5B	1.715(43.56)	1.871(47.52)

A

B

C

D

E

F

A



B

C

D

E

F

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 19/SEP/15	PART NO. FWF39602-SXXB2XXXB	ITEM NO. FWF39602	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X.X±.008(0.20) X.XX±.006(0.15) X.XXX±.004(0.10)	X.±5' .X'±2" .XX'±1" .XXX'±0.5'	CHECKED BY CHERRY	DATE 19/SEP/15	TITLE Wire to Board (Wafer) Pitch 3.96mm 90° Angle (DIP)		REV 3
	SCALE 5:1	SIZE A4	DRAWN BY JACOB	DATE 19/SEP/15	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

1 2 3 4 5 6 7 8